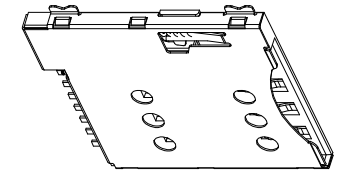
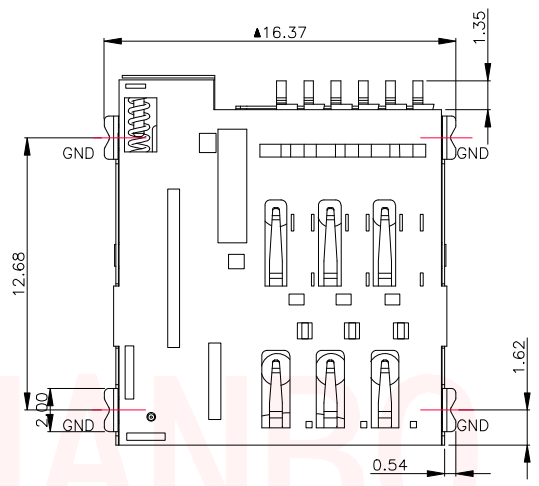
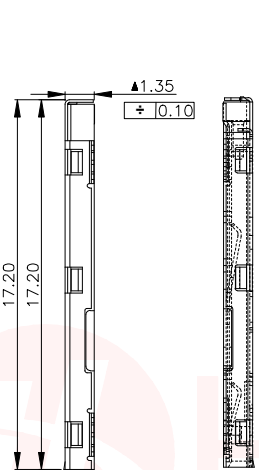
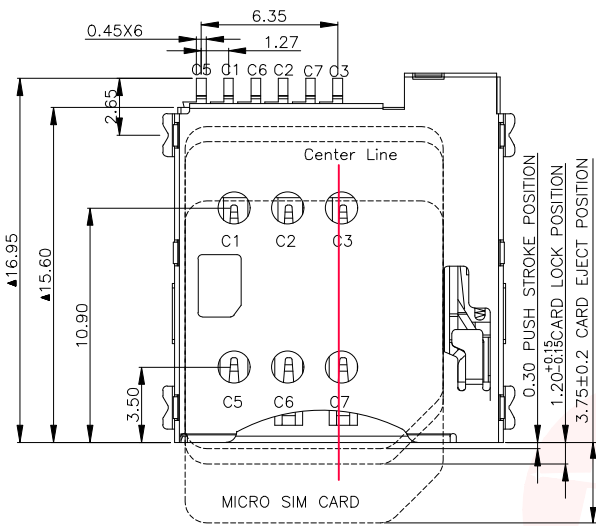




5	6
REV.	ECN NO OR DESCRIPTION
REVISED	DATE

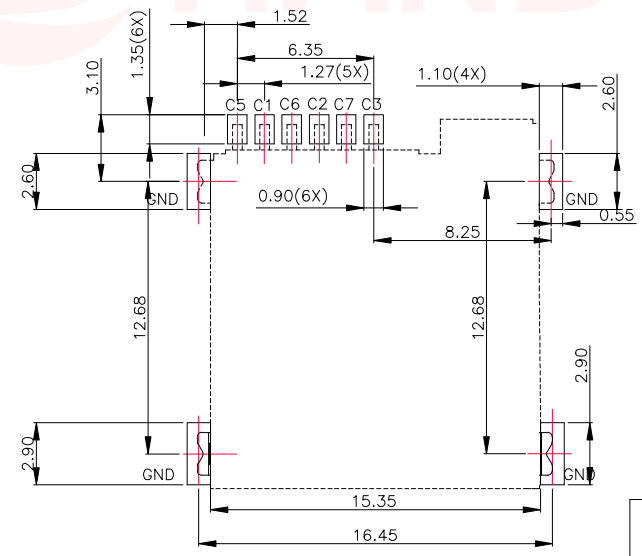
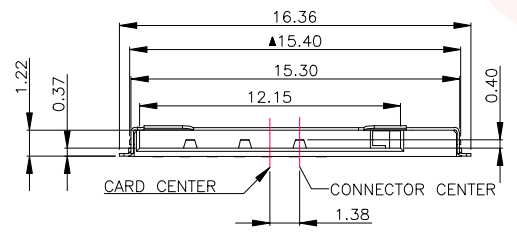


Specification

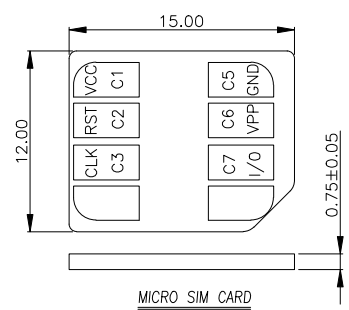
MATERIAL:
 Insulator: High Temperature Thermoplastic, UL 94V-0.
 Contact: Copper Alloy
 SHELL: SUS

PLATING:
 Contact: Plated 50u" Ni Over all Contact Au 1U
 Shell: Plated 50u" Ni Overall
 Plated 1u"Au Selective Contact Area

Electrical:
 Current Rating :0.5mA
 Voltage Rating :5V AC/DC
 Ambient Temperature Range :-20°C~+60°C
 Storage Temperature Range :-40°C~+85°C
 Ambient Humidity Range :95% R.H. Max.
 Contact Resistance:100M Ω max.
 Insulation Resistance:1000M Ω min./500VDC
 产品耐温温度: 260°C $T_c \le 1.70^\circ C, T_c > 1.70^\circ C > +5^\circ C$
 Mating Cycles:1500Min Insertions



SIM pin assignment	
PIN#	Name
C1	VCC供电电压
C2	RST重置
C3	CLK时钟
C5	GND接地
C6	VPP程序电压
C7	I/O输入输出



RECOMMENDED PCB LAYOUT
 GENERAL TOLERANCE ±0.05

UNLESS OTHERWISE SPECIFIED TOLERANCES		东莞市汉博电子科技有限公司 DONGGUAN HANBO TECHNOLOGY CO., LTD			
DECIMALS:	ANGLES:	TITLE	6pin H1.35 push push micro sim card		
X :±0.15	X :±2°	DWN	xiong	PART NO. SIM-200-P6	
X.X :±0.10	X.X :±1°	CHKD	lee	SCALE:1:1	UNIT: mm
X.XX :±0.05		APVD	wang	SIZE: A4	SHEET:10F 1
		REV: A4			
CUSTOMER COPY					